

Grounding & Bonding
Compression Device
Bus Bar Tap

HUBBELL

Features

- Irreversible bond to 0.25" thick bus bar
- Save lug mounting holes for lugs
- Antioxidant included and applied to inside of clamp

Ordering Information

Busbar	Conductor Size	Catalog Number	UPC Number
0.25"	4/0 - 1/0 AWG	HYG14BTC28	662620318318

Listings

UL
TIA-607 Compliant

Specifications

Material	Copper
Configuration	H-Tap
Plating	Tin

Characteristics

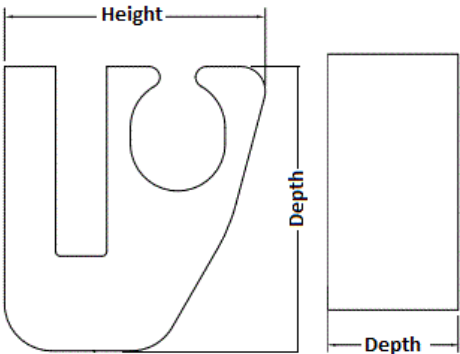
Bond Type	Irreversible Compression
Die Index	1105

Accessories

Die	
Die	
6 Ton Power Tool	HPAT600LI
12 Ton Power Tool	HPAT750LI
12' Conductor	HGRKTD144D

Online Resources

Brochure
Customer Drawing
Customer Use Drawing
eCatalog



Dimensions- inches (mm)

Height	1.4" (36)
Depth	0.8" (20)
Depth	1.5" (38)